

Vishay Semiconductors

Two-Line ESD-Protection in SOT23

Features

- Two-line ESD-protection device
- ESD-immunity acc. IEC 61000-4-2 ± 30 kV contact discharge ± 30 kV air discharge
- Space saving SOT23 package
- AEC Q101 qualified
- Lead (Pb)-free component
- Lead finish = "e3" = matte tin (Sn)
- Component in accordance to RoHS 2002/95/EC and WEEE 2002/96/EC

20357

Marking (example only)



YYY = Type code (see table below) XX = Date code

Ordering Information

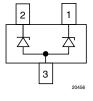
Device name	Ordering code	Taped units per reel (8 mm tape on 7" reel)	Minimum order quantity
GSOT03C	GSOT03C-GS08	3000	15 000
GSOT04C	GSOT04C-GS08	3000	15 000
GSOT05C	GSOT05C-GS08	3000	15 000
GSOT08C	GSOT08C-GS08	3000	15 000
GSOT12C	GSOT12C-GS08	3000	15 000
GSOT15C	GSOT15C-GS08	3000	15 000
GSOT24C	GSOT24C-GS08	3000	15 000
GSOT36C	GSOT36C-GS08	3000	15 000

Package Data

Device name	Package name	Marking code	Weight	Molding compound flammability rating	Moisture sensitivity level	Soldering conditions
GSOT03C	SOT23	03C	8.8 mg	UL 94 V-0	MSL level 1 (according J-STD-020)	260 °C/10 s at terminals
GSOT04C	SOT23	04C	8.8 mg	UL 94 V-0	MSL level 1 (according J-STD-020)	260 °C/10 s at terminals
GSOT05C	SOT23	05C	8.8 mg	UL 94 V-0	MSL level 1 (according J-STD-020)	260 °C/10 s at terminals
GSOT08C	SOT23	08C	8.8 mg	UL 94 V-0	MSLlevel 1 (according J-STD-020)	260 °C/10 s at terminals
GSOT12C	SOT23	12C	8.8 mg	UL 94 V-0	MSL level 1 (according J-STD-020)	260 °C/10 s at terminals
GSOT15C	SOT23	15C	8.8 mg	UL 94 V-0	MSL level 1 (according J-STD-020)	260 °C/10 s at terminals
GSOT24C	SOT23	24C	8.8 mg	UL 94 V-0	MSL level 1 (according J-STD-020)	260 °C/10 s at terminals
GSOT36C	SOT23	36C	8.8 mg	UL 94 V-0	MSL level 1 (according J-STD-020)	260 °C/10 s at terminals







VISHAY.

Vishay Semiconductors

Absolute Maximum Ratings GSOT03C

Rating	Test condition	Symbol	Value	Unit
Deals pulse surrent	Pin 1 to 3 or pin 2 to 3 Acc. IEC 61000-4-5, $t_P = 8/20 \ \mu s$; single shot	I _{PPM}	30	А
Peak pulse current Pin 1 to 2 or pin 2 to 1; pin 3 not connected Acc. IEC 61000-4-5, $t_P = 8/20 \mu_S$; single shot		I _{PPM}	30	А
	Pin 1 to 3 or pin 2 to 3 Acc. IEC 61000-4-5, $t_p = 8/20 \ \mu s$; single shot	P _{PP}	369	W
Peak pulse power	Pin 1 to 2 or pin 2 to 1; pin 3 not connected Acc. IEC 61000-4-5, $t_P = 8/20 \ \mu s$; single shot	P _{PP}	504	W
	Contact discharge acc. IEC 61000-4-2; 10 pulses	V _{ESD}	± 30	kV
ESD immunity	Air discharge acc. IEC 61000-4-2; 10 pulses	V _{ESD}	± 30	kV
Operating temperature	Junction temperature	TJ	- 40 to + 125	°C
Storage temperature		T _{STG}	- 55 to + 150	°C

GSOT04C

Rating	Test condition	Symbol	Value	Unit
Peak pulse ourrant	Pin 1 to 3 or pin 2 to 3 Acc. IEC 61000-4-5, $t_P = 8/20 \ \mu s$; single shot	I _{PPM}	30	А
Peak pulse current	Pin 1 to 2 or pin 2 to 1; pin 3 not connected Acc. IEC 61000-4-5, $t_p = 8/20 \ \mu$ s; single shot	I _{PPM}	30	A
	Pin 1 to 3 or pin 2 to 3 Acc. IEC 61000-4-5, $t_P = 8/20 \ \mu s$; single shot	P _{PP}	429	W
Peak pulse power	Pin 1 to 2 or pin 2 to 1; pin 3 not connected Acc. IEC 61000-4-5, $t_P = 8/20 \ \mu s$; single shot	P _{PP}	564	W
ESD immunity	Contact discharge acc. IEC 61000-4-2; 10 pulses	V _{ESD}	± 30	kV
	Air discharge acc. IEC 61000-4-2; 10 pulses	V _{ESD}	± 30	kV
Operating temperature	Junction temperature	Т _Ј	- 40 to + 125	°C
Storage temperature		T _{STG}	- 55 to + 150	°C

GSOT05C

Rating	Test condition	Symbol	Value	Unit
Peak pulse current	Pin 1 to 3 or pin 2 to 3 Acc. IEC 61000-4-5, t _P = 8/20 μ s; single shot	I _{PPM}	30	А
Peak pulse current	Pin 1 to 2 or pin 2 to 1; pin 3 not connected Acc. IEC 61000-4-5, $t_p = 8/20 \ \mu s$; single shot	I _{PPM}	30	A
	Pin 1 to 3 or pin 2 to 3 Acc. IEC 61000-4-5, $t_P = 8/20 \ \mu s$; single shot	P _{PP}	480	W
Peak pulse power	Pin 1 to 2 or pin 2 to 1; pin 3 not connected Acc. IEC 61000-4-5, $t_P = 8/20 \ \mu s$; single shot	P _{PP}	612	W
ESD immunity	Contact discharge acc. IEC 61000-4-2; 10 pulses	V _{ESD}	± 30	kV
	Air discharge acc. IEC 61000-4-2; 10 pulses	V _{ESD}	± 30	kV
Operating temperature	Junction temperature	Т _Ј	- 40 to + 125	°C
Storage temperature		T _{STG}	- 55 to + 150	°C



Vishay Semiconductors

GSOT08C

Rating	Test condition	Symbol	Value	Unit
Peak pulse ourrept	Pin 1 to 3 or pin 2 to 3 Acc. IEC 61000-4-5, $t_p = 8/20 \ \mu s$; single shot	I _{PPM}	18	А
Peak pulse current	Pin 1 to 2 or pin 2 to 1; pin 3 not connected Acc. IEC 61000-4-5, $t_p = 8/20 \ \mu$ s; single shot	I _{PPM}	18	A
	Pin 1 to 3 or pin 2 to 3 Acc. IEC 61000-4-5, $t_P = 8/20 \ \mu s$; single shot	P _{PP}	345	w
Peak pulse power	Pin 1 to 2 or pin 2 to 1; pin 3 not connected Acc. IEC 61000-4-5, $t_p = 8/20 \ \mu s$; single shot	P _{PP}	400	w
ESD immunity	Contact discharge acc. IEC 61000-4-2; 10 pulses	V _{ESD}	± 30	kV
	Air discharge acc. IEC 61000-4-2; 10 pulses	V _{ESD}	± 30	kV
Operating temperature	Junction temperature	ТJ	- 40 to + 125	°C
Storage temperature		T _{STG}	- 55 to + 150	°C

GSOT12C

Rating	Test condition	Symbol	Value	Unit
Pook pulso autropt	Pin 1 to 3 or pin 2 to 3 Acc. IEC 61000-4-5, $t_P = 8/20 \ \mu s$; single shot	I _{PPM}	12	А
Peak pulse current	Pin 1 to 2 or pin 2 to 1; pin 3 not connected Acc. IEC 61000-4-5, $t_P = 8/20 \ \mu s$; single shot	I _{PPM}	12	А
Deels aulee neuron	Pin 1 to 3 or pin 2 to 3 Acc. IEC 61000-4-5, $t_P = 8/20 \ \mu s$; single shot	P _{PP}	312	W
Peak pulse power	Pin 1 to 2 or pin 2 to 1; pin 3 not connected Acc. IEC 61000-4-5, $t_P = 8/20 \ \mu s$; single shot	P _{PP}	337	W
ESD immunity	Contact discharge acc. IEC 61000-4-2; 10 pulses	V _{ESD}	± 30	kV
	Air discharge acc. IEC 61000-4-2; 10 pulses	V _{ESD}	± 30	kV
Operating temperature	Junction temperature	ТJ	- 40 to + 125	°C
Storage temperature		T _{STG}	- 55 to + 150	°C

GSOT15C

Rating	Test condition	Symbol	Value	Unit
Peak pulse current	Pin 1 to 3 or pin 2 to 3 Acc. IEC 61000-4-5, $t_p = 8/20 \ \mu s$; single shot	I _{PPM}	8	А
reak puise current	Pin 1 to 2 or pin 2 to 1; pin 3 not connected Acc. IEC 61000-4-5, $t_P = 8/20 \ \mu$ s; single shot	I _{PPM}	8	А
	Pin 1 to 3 or pin 2 to 3 Acc. IEC 61000-4-5, $t_P = 8/20 \ \mu s$; single shot	P _{PP}	230	w
Peak pulse power	Pin 1 to 2 or pin 2 to 1; pin 3 not connected Acc. IEC 61000-4-5, $t_p = 8/20 \ \mu s$; single shot	P _{PP}	245	W
ESD immunity	Contact discharge acc. IEC 61000-4-2; 10 pulses	V _{ESD}	± 30	kV
	Air discharge acc. IEC 61000-4-2; 10 pulses	V _{ESD}	± 30	kV
Operating temperature	Junction temperature	ТJ	- 40 to + 125	°C
Storage temperature		T _{STG}	- 55 to + 150	°C

Vishay Semiconductors



GSOT24C

Rating	Test condition	Symbol	Value	Unit
Peak pulse aurrent	Pin 1 to 3 or pin 2 to 3 Acc. IEC 61000-4-5, $t_p = 8/20 \ \mu s$; single shot	I _{PPM}	5	А
Peak pulse current	Pin 1 to 2 or pin 2 to 1; pin 3 not connected Acc. IEC 61000-4-5, $t_P = 8/20 \ \mu s$; single shot	I _{PPM}	5	A
	Pin 1 to 3 or pin 2 to 3 Acc. IEC 61000-4-5, $t_P = 8/20 \ \mu s$; single shot	P _{PP}	235	W
Peak pulse power	Pin 1 to 2 or pin 2 to 1; pin 3 not connected Acc. IEC 61000-4-5, $t_p = 8/20 \ \mu s$; single shot	P _{PP}	240	W
ESD immunity	Contact discharge acc. IEC 61000-4-2; 10 pulses	V _{ESD}	± 30	kV
	Air discharge acc. IEC 61000-4-2; 10 pulses	V _{ESD}	± 30	kV
Operating temperature	Junction temperature	ТJ	- 40 to + 125	°C
Storage temperature		T _{STG}	- 55 to + 150	°C

GSOT36C

Rating	Test condition	Symbol	Value	Unit
Peak pulse aurrent	Pin 1 to 3 or pin 2 to 3 Acc. IEC 61000-4-5, t _P = 8/20 μ s; single shot	I _{PPM}	3.5	А
Peak pulse current	Pin 1 to 2 or pin 2 to 1; pin 3 not connected Acc. IEC 61000-4-5, $t_p = 8/20 \ \mu s$; single shot	I _{PPM}	3.5	А
	Pin 1 to 3 or pin 2 to 3 Acc. IEC 61000-4-5, $t_P = 8/20 \ \mu s$; single shot	P _{PP}	248	W
Peak pulse power	Pin 1 to 2 or pin 2 to 1; pin 3 not connected Acc. IEC 61000-4-5, $t_P = 8/20 \ \mu s$; single shot	P _{PP}	252	W
ESD immunity	Contact discharge acc. IEC 61000-4-2; 10 pulses	V _{ESD}	± 30	kV
	Air discharge acc. IEC 61000-4-2; 10 pulses	V _{ESD}	± 30	kV
Operating temperature	Junction temperature	Т _Ј	- 40 to + 125	°C
Storage temperature		T _{STG}	- 55 to + 150	°C



Vishay Semiconductors

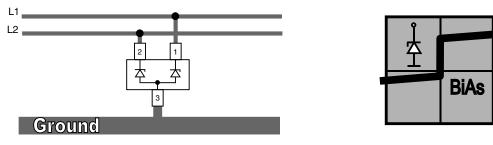
BiAs-Mode (2-line Bidirectional Asymmetrical protection mode)

With the **GSOTxxC** two signal- or data-lines (L1, L2) can be protected against voltage transients. With pin 3 connected to ground and pin 1 and pin 2 connected to a signal- or data-line which has to be protected. As long as the voltage level on the data- or signal-line is between 0 V (ground level) and the specified **M**aximum **R**everse **W**orking Voltage (V_{RWM}) the protection diode between pin 2 and pin 3 and between pin 1 and pin 3 offer a high isolation to the ground line. The protection device behaves like an open switch.

As soon as any positive transient voltage signal exceeds the break through voltage level of the protection diode, the diode becomes conductive and shorts the transient current to ground. Now the protection device behaves like a closed switch. The Clamping Voltage (V_C) is defined by the **BR**eakthrough Voltage (V_{BR}) level plus the voltage drop at the series impedance (resistance and inductance) of the protection device.

Any negative transient signal will be clamped accordingly. The negative transient current is flowing in the forward direction of the protection diode. The low **F**orward **V**oltage (V_F) clamps the negative transient close to the ground level.

Due to the different clamping levels in forward and reverse direction the **GSOTxxC** clamping behaviour is **<u>Bi</u>**directional and <u>Asymmetrical</u> (**BiAs**).

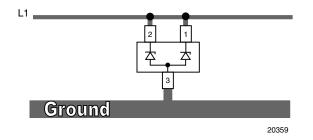


20358

If a higher surge current or **P**eak **P**ulse **current** (**I**_{**PP**}) is needed, both protection diodes in the **GSOTxxC** can also be used in parallel in order to "double" the performance.

This offers: • double surge power = double peak pulse current (2 x I_{PPM})

- halve line inductance = reduced clamping voltage
- halve line resistance = reduced clamping voltage
- double Diode Capacitance (2 x C_D)
- double Reverse leakage current (2 x I_R)





Vishay Semiconductors

Electrical Characteristics Ratings at 25 °C, ambient temperature unless otherwise specified

GSOT03C

BiAs mode (between Pin 1 to 3 or pin 2 to 3)

Parameter	Test conditions/remarks	Symbol	Min.	Тур.	Max.	Unit
Protection paths	Number of lines which can be protected	N _{lines}			2	lines
Reverse stand off voltage	at I _R = 100 μA	V _{RWM}	3.3			V
Reverse current	at V _R = 3.3 V	I _R			100	μA
Reverse break down voltage	at I _R = 1 mA	V _{BR}	4	4.6		V
Reverse clamping voltage	at I _{PP} = 1 A	V _C		5.7	7.5	V
neverse clamping voltage	at I _{PP} = I _{PPM} = 30 A	V _C		10	2	V
Forward elemning voltage	at I _{PP} = 1 A	V _F		1	1.2	V
Forward clamping voltage	at I _{PP} = I _{PPM} = 30 A	V _F		4.5		V
Capacitanaa	at V _R = 0 V; f = 1 MHz	CD		420	600	pF
Capacitance	at V _R = 1.6 V; f = 1 MHz	CD		260	.6 .7 7.5 10 12.3 1 1.2 .5 .20	pF

GSOT04C

BiAs mode (between Pin 1 to 3 or pin 2 to 3)

Parameter	Test conditions/remarks	Symbol	Min.	Тур.	Max.	Unit
Protection paths	Number of lines which can be protected	N _{lines}			2	lines
Reverse stand off voltage	at I _R = 20 μA	V _{RWM}	4			V
Reverse current	at V _R = 4 V	I _R			20	μA
Reverse break down voltage	at I _R = 1 mA	V _{BR}	5	6.1		V
Deverse elempine veltage	at I _{PP} = 1 A	V _C		7.5	9	V
Reverse clamping voltage	at I _{PP} = I _{PPM} = 30 A	V _C		11.2	2 20	V
Forward elemping veltage	at I _{PP} = 1 A	V _F		1	1.2	V
Forward clamping voltage	at I _{PP} = I _{PPM} = 30 A	V _F		4.5	2 20 9 14.3 1.2	V
Canaaitanaa	at $V_R = 0$ V; f = 1 MHz	CD		310	450	pF
Capacitance	at $V_R = 2 V$; f = 1 MHz	CD		200		pF

GSOT05C

BiAs mode (between Pin 1 to 3 or pin 2 to 3)

Parameter	Test conditions/remarks	Symbol	Min.	Тур.	Max.	Unit
Protection paths	Number of lines which can be protected	N _{lines}			2	lines
Reverse stand off voltage	at I _R = 10 μA	V _{RWM}	5			V
Reverse current	at V _R = 5 V	I _R			10	μΑ
Reverse break down voltage	at I _R = 1 mA	V_{BR}	6	6.8		V
Deverse elemning veltage	at I _{PP} = 1 A	V _C		7	8.7	V
Reverse clamping voltage	at I _{PP} = I _{PPM} = 30 A	V _C		12	16	V
Forward elemning valtage	at I _{PP} = 1 A	V _F		1	1.2	V
Forward clamping voltage	at I _{PP} = I _{PPM} = 30 A	V _F		4.5		V
Canacitanaa	at V _R = 0 V; f = 1 MHz	CD		260	350	pF
Capacitance	at V _R = 2.5 V; f = 1 MHz	CD		150		pF



Vishay Semiconductors

GSOT08C BiAs mode (between Pin 1 to 3 or pin 2 to 3)

Parameter	Test conditions/remarks	Symbol	Min.	Тур.	Max.	Unit
Protection paths	Number of lines which can be protected	N _{lines}			2	lines
Reverse stand off voltage	at I _R = 5 μA	V _{RWM}	8			V
Reverse current	at V _R = 8 V	I _R			5	μA
Reverse break down voltage	at I _R = 1 mA	V _{BR}	9	10		V
Deverse elemping veltage	at I _{PP} = 1 A	V _C		10.7	13	V
Reverse clamping voltage	at I _{PP} = I _{PPM} = 18 A	V _C		15.2	19.2	V
Forward elemping voltage	at I _{PP} = 1 A	V _F		1	1.2	V
Forward clamping voltage	at I _{PP} = I _{PPM} = 18 A	V _F		3		V
Canaaitanaa	at $V_R = 0$ V; f = 1 MHz	CD		160	250	pF
Capacitance	at $V_R = 4 V$; f = 1 MHz	CD		80		pF

GSOT12C

BiAs mode (between pin 1 to 3 or pin 2 to 3)

Parameter	Test conditions/remarks	Symbol	Min.	Тур.	Max.	Unit
Protection paths	Number of lines which can be protected	N _{lines}			2	lines
Reverse stand off voltage	at I _R = 1 μA	V _{RWM}	12			V
Reverse current	at V _R = 12 V	I _R			1	μA
Reverse break down voltage	at I _R = 1 mA	V _{BR}	13.5	15		V
Reverse clamping voltage	at I _{PP} = 1 A	V _C		15.4	18.7	V
neverse clamping vollage	at I _{PP} = I _{PPM} = 12 A	V _C		21.2	26	V
Forward elemping voltage	at I _{PP} = 1 A	V _F		1	1.2	V
Forward clamping voltage	at I _{PP} = I _{PPM} = 12 A	V _F		2.2		V
Canacitanaa	at $V_R = 0$ V; f = 1 MHz	CD		115	150	pF
Capacitance	at $V_R = 6 V$; f = 1 MHz	CD		50		pF

GSOT15C

BiAs mode (between pin 1 to 3 or pin 2 to 3)

Parameter	Test conditions/remarks	Symbol	Min.	Тур.	Max.	Unit
Protection paths	Number of lines which can be protected	N _{lines}			2	lines
Reverse stand off voltage	at I _R = 1 μA	V _{RWM}	15			V
Reverse current	at V _R = 15 V	I _R			1	μA
Reverse break down voltage	at I _R = 1 mA	V _{BR}	16.5	18		V
Reverse clamping voltage	at I _{PP} = 1 A	V _C		19.4	23.5	V
neverse clamping vollage	at I _{PP} = I _{PPM} = 8 A	V _C		24.8	28.8	V
Forward elemping voltage	at I _{PP} = 1 A	V _F		1	1.2	V
Forward clamping voltage	at I _{PP} = I _{PPM} = 8 A	V _F		1.8		V
Canaaitanaa	at $V_R = 0$ V; f = 1 MHz	CD		90	120	pF
Capacitance	at V _R = 7.5 V; f = 1 MHz	CD		35		pF

Vishay Semiconductors



GSOT24C

BiAs mode (between pin 1 to 3 or pin 2 to 3)

Parameter	Test conditions/remarks	Symbol	Min.	Тур.	Max.	Unit
Protection paths	Number of lines which can be protected	N _{lines}			2	lines
Reverse stand off voltage	at I _R = 1 μA	V _{RWM}	24			V
Reverse current	at V _R = 24 V	I _R			1	μA
Reverse break down voltage	at I _R = 1 mA	V _{BR}	27	30		V
Deverse elemping veltage	at I _{PP} = 1 A	V _C		34	41	V
Reverse clamping voltage	at I _{PP} = I _{PPM} = 5 A	V _C		41	47	V
Forward elemning valtage	at I _{PP} = 1 A	V _F		1	1.2	V
Forward clamping voltage	at I _{PP} = I _{PPM} = 5 A	V _F		1.4		V
Canacitanaa	at V _R = 0 V; f = 1 MHz	CD		65	80	pF
Capacitance	at V _R = 12 V; f = 1 MHz	CD		20		pF

GSOT36C

BiAs mode (between pin 1 to 3 or pin 2 to 3)

Parameter	Test conditions/remarks	Symbol	Min.	Тур.	Max.	Unit
Protection paths	Number of lines which can be protected	N _{lines}			2	lines
Reverse stand off voltage	at I _R = 1 μA	V _{RWM}	36			V
Reverse current	at V _R = 36 V	I _R			1	μA
Reverse break down voltage	at I _R = 1 mA	V _{BR}	39	43		V
Reverse clamping voltage	at I _{PP} = 1 A	V _C		49	60	V
neverse clamping vollage	at $I_{PP} = I_{PPM} = 3.5 \text{ A}$	V _C		59	71	V
Forward clamping voltage	at I _{PP} = 1 A	V _F		1	1.2	V
Forward clamping voltage	at I _{PP} = I _{PPM} = 3.5 A	V _F		1.3		V
Capacitance	at $V_{R} = 0$ V; f = 1 MHz	CD		52	65	pF
Capacitarice	at V _R = 18 V; f = 1 MHz	CD		12		pF



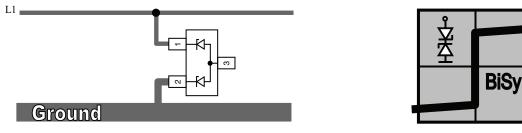
Vishay Semiconductors

BiSy-mode (1-line Bidirectional Symmetrical protection mode)

If a bipolar symmetrical protection device is needed the **GSOTxxC** can also be used as a single line protection device. Therefore pin 1 has to be connected to the signal- or data-line (L1) and pin 2 to ground (or vice versa). pin 3 must not be connected.

Positive and negative voltage transients will be clamped in the same way. The clamping current through the **GSOTxxC** passes one diode in forward direction and the other one in reverse direction. The **C**lamping Voltage (V_C) is defined by the **BR**eakthrough Voltage (V_{BR}) level of one diode plus the forward voltage of the other diode plus the voltage drop at the series impedances (resistances and inductances) of the protection device.

Due to the same clamping levels in positive and negative direction the **GSOTxxC** voltage clamping behaviour is **<u>Bi</u>**directional and **<u>Sy</u>**mmetrical (**BiSy**).



20361

Electrical Characteristics

Ratings at 25 °C, ambient temperature unless otherwise specified

GSOT03C

BiSy mode (between pin 1 to 2 or pin 2 to 1; pin 3 not connected)

Parameter	Test conditions/remarks	Symbol	Min.	Тур.	Max.	Unit
Protection paths	Number of lines which can be protected	N _{lines}			1	lines
Reverse stand off voltage	at I _R = 100 μA	V _{RWM}	3.8			V
Reverse current	at V _R = 3.8 V	I _R			100	μA
Reverse break down voltage	at I _R = 1 mA	V_{BR}	4.5	5.3		V
Clamping voltage	at I _{PP} = 1 A	V _C		7	8.4	V
Clamping voltage	at I _{PP} = I _{PPM} = 30 A	V _C		14	16.8	V
Canaaitanaa	at $V_R = 0 V$; f = 1 MHz	CD		210	300	pF
Capacitance	at V _R = 1.6 V; f = 1 MHz	CD		190		pF

GSOT04C

BiSy mode (between pin 1 to 2 or pin 2 to 1; pin 3 not connected)

Parameter	Test conditions/remarks	Symbol	Min.	Тур.	Max.	Unit
Protection paths	Number of lines which can be protected	N _{lines}			1	lines
Reverse stand off voltage	at I _R = 20 μA	V _{RWM}	4.5			V
Reverse current	at V _R = 4.5 V	I _R			20	μA
Reverse break down voltage	at I _R = 1 mA	V_{BR}	5.5	6.8		V
Clamping voltage	at I _{PP} = 1 A	V _C		7.5	9	V
Clamping voltage	at I _{PP} = I _{PPM} = 30 A	V _C		15.7	18.8	V
Conceitonee	at V _R = 0 V; f = 1 MHz	CD		155	225	pF
Capacitance	at V _R = 2 V; f = 1 MHz	CD		135		pF

Vishay Semiconductors



GSOT05C

BiSy mode (between pin 1 to 2 or pin 2 to 1; pin 3 not connected)

Parameter	Test conditions/remarks	Symbol	Min.	Тур.	Max.	Unit
Protection paths	Number of lines which can be protected	N _{lines}			1	lines
Reverse stand off voltage	at I _R = 10 μA	V _{RWM}	5.5			V
Reverse current	at V _R = 5.5 V	I _R			10	μΑ
Reverse break down voltage	at I _R = 1 mA	V _{BR}	6.5	7.5		V
Clomping voltage	at I _{PP} = 1 A	V _C		8.1	9.7	V
Clamping voltage	at I _{PP} = I _{PPM} = 30 A	V _C		17	20.4	V
Canacitanaa	at V _R = 0 V; f = 1 MHz	CD		130	175	pF
Capacitance	at V _R = 2.5 V; f = 1 MHz	CD		100		pF

GSOT08C

BiSy mode (between pin 1 to 2 or pin 2 to 1; pin 3 not connected)

Parameter	Test conditions/remarks	Symbol	Min.	Тур.	Max.	Unit
Protection paths	Number of lines which can be protected	N _{lines}			1	lines
Reverse stand off voltage	at I _R = 5 μA	V _{RWM}	8.5			V
Reverse current	at V _R = 8.5 V	I _R			5	μΑ
Reverse break down voltage	at I _R = 1 mA	V_{BR}	9.5	10.7		V
Clamping voltage	at I _{PP} = 1 A	V _C		11.7	14	V
Clamping voltage	at I _{PP} = I _{PPM} = 18 A	V _C		18.5	22.2	V
Capacitance	at $V_R = 0$ V; f = 1 MHz	CD		80	125	pF
Capacitance	at V _R = 4 V; f = 1 MHz	CD		60		pF

GSOT12C

BiSy mode (between pin 1 to 2 or pin 2 to 1; pin 3 not connected)

Parameter	Test conditions/remarks	Symbol	Min.	Тур.	Max.	Unit
Protection paths	Number of lines which can be protected	N _{lines}			1	lines
Reverse stand off voltage	at I _R = 1 μA	V _{RWM}	12.5			V
Reverse current	at V _R = 12.5 V	I _R			1	μA
Reverse break down voltage	at I _R = 1 mA	V _{BR}	13.5	15.7		V
Clamping voltage	at I _{PP} = 1 A	V _C		16.4	19.7	V
Clamping voltage	at I _{PP} = I _{PPM} = 12 A	V _C		23.4	28.1	V
Conceitonee	at V _R = 0 V; f = 1 MHz	CD		58	75	pF
Capacitance	at V _R = 6 V; f = 1 MHz	CD		36		pF

GSOT15C

BiSy mode (between pin 1 to 2 or pin 2 to 1; pin 3 not connected)

Parameter	Test conditions/remarks	Symbol	Min.	Тур.	Max.	Unit
Protection paths	Number of lines which can be protected	N _{lines}			1	lines
Reverse stand off voltage	at I _R = 1 μA	V _{RWM}	15.5			V
Reverse current	at V _R = 15.5 V	I _R			1	μA
Reverse break down voltage	at I _R = 1 mA	V _{BR}	17	18.7		V
Clamping voltage	at I _{PP} = 1 A	V _C		20.4	24.5	V
Clamping voltage	at I _{PP} = I _{PPM} = 8 A	V _C		26.6	30.6	V
Capacitance	at V _R = 0 V; f = 1 MHz	CD		45	60	pF
Capacitance	at V _R = 7.5 V; f = 1 MHz	CD		25		pF



Vishay Semiconductors

GSOT24C

BiSy mode (between pin 1 to 2 or pin 2 to 1; pin 3 not connected)

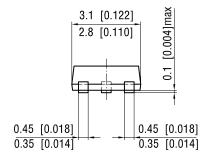
Parameter	Test conditions/remarks	Symbol	Min.	Тур.	Max.	Unit
Protection paths	Number of lines which can be protected	N _{lines}			1	lines
Reverse stand off voltage	at I _R = 1 μA	V _{RWM}	24.5			V
Reverse current	at V _R = 24.5 V	I _R			1	μA
Reverse break down voltage	at I _R = 1 mA	V_{BR}	27.5	30.7		V
Clamping voltage	at I _{PP} = 1 A	V _C		34	41	V
	at I _{PP} = I _{PPM} = 5 A	V _C		40	48	V
Capacitance	at $V_R = 0$ V; f = 1 MHz	CD		33	40	pF
	at V _R = 12 V; f = 1 MHz	CD		18		pF

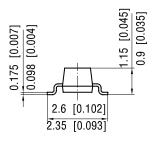
GSOT36C

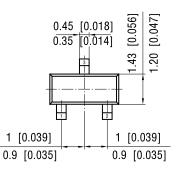
BiSy mode (between pin 1 to 2 or pin 2 to 1; pin 3 not connected)

Parameter	Test conditions/remarks	Symbol	Min.	Тур.	Max.	Unit
Protection paths	Number of lines which can be protected	N _{lines}			1	lines
Reverse stand off voltage	at I _R = 1 μA	V _{RWM}	36.5			V
Reverse current	at V _R = 36.5 V	I _R			1	μA
Reverse break down voltage	at I _R = 1 mA	V_{BR}	39.5	43.7		V
Clamping voltage	at I _{PP} = 1 A	V _C		50	60	V
	at I _{PP} = I _{PPM} = 3.5 A	V _C		60	72	V
Capacitance	at $V_{R} = 0 V$; f = 1 MHz	CD		26	33	pF
	at V _R = 18 V; f = 1 MHz	CD		10		pF

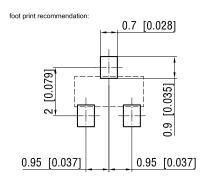
Package Dimensions in millimeters (inches): SOT23







Document no.: 6.541-5014.01-4 Rev. 7 - Date: 08.July.2004 17418



Vishay Semiconductors



Ozone Depleting Substances Policy Statement

It is the policy of Vishay Semiconductor GmbH to

- 1. Meet all present and future national and international statutory requirements.
- 2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

- 1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively.
- 2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA.
- 3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

We reserve the right to make changes to improve technical design and may do so without further notice.

Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use Vishay Semiconductors products for any unintended or unauthorized application, the buyer shall indemnify Vishay Semiconductors against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

Vishay Semiconductor GmbH, P.O.B. 3535, D-74025 Heilbronn, Germany



Vishay

Disclaimer

All product specifications and data are subject to change without notice.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained herein or in any other disclosure relating to any product.

Vishay disclaims any and all liability arising out of the use or application of any product described herein or of any information provided herein to the maximum extent permitted by law. The product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein, which apply to these products.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications unless otherwise expressly indicated. Customers using or selling Vishay products not expressly indicated for use in such applications do so entirely at their own risk and agree to fully indemnify Vishay for any damages arising or resulting from such use or sale. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

Product names and markings noted herein may be trademarks of their respective owners.